

Amendments to the Specification

Amend the first paragraph on page 24 to read as follows:

--One approach (Fig. 9) is to provide heatspreader 500 with a second surface 510 at an angle to its first surface 73 (and hence to the layers of the chip 50). As shown in Fig. 9, the second surface 510 of heatspreader 500 is non-parallel or at a non-parallel angle to the opposing first surface 73 and to the layers of the chip. Heatspreader 500 thus has a truncated wedge-shape. Reflections from surface 500 are thus reflected out of the cavity, rather than towards mirror 20, and so resonant reflections do not build up.--